



DMN3731U

Product Summary

BV _{DSS}	Max R _{DS(ON)}	I_D Max T _A = +25°C
201/	460mΩ @ V _{GS} = 4.5V	0.9A
30V	560mΩ @ V _{GS} = 2.5V	0.83A

Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ yet maintain superior switching performance, which makes it ideal for high-efficiency power management applications.

- Load Switch
- Portable Applications
- Power Management Functions

30V N-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- Low V_{GS(TH)}, can be Driven Directly from a Battery
- Low R_{DS(ON)}
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

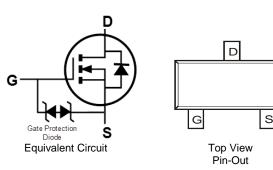
- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 ⁽²³⁾
- Terminals Connections: See Diagram Below
- Weight: 0.009 grams (Approximate)





SOT23

Top View



Ordering Information (Note 4)

Part Number	Marking	Reel size (inches)	Quantity per Reel
DMN3731U-7	BR3	7	3,000
DMN3731U-13	BR3	13	10,000

Notes: 1.

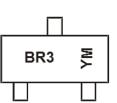
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



BR3 = Product Type Marking Code YM or \overline{YM} = Date Code Marking Y or \overline{Y} =Year (ex: G = 2019) M = Month (ex: 9 = September)

Date Code Key			L									
Year	201	8	2019		2020	20	21	2022		2023	2	2024
Code	F		G		Н		I	J		К		L
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = 25°C unless otherwise specified)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±8	V
Continuous Drain Current (Note 6) V_{GS} = 4.5V	Steady State			0.9 0.7	А
Maximum Continuous Body Diode Forward Curre	ent (Note 6)	Is	0.55	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle =	I _{DM}	3	А		

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	0.4	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	303	°C/W
Total Power Dissipation (Note 6)		PD	0.58	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{0JA}	215	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = 25°C unless otherwise specified)

		-	-	-		-	
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	—	—	V	$V_{GS} = 0V, I_D = 10\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}			1	μA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	—	—	3	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	0.45	—	0.95	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
			271	460		$V_{GS} = 4.5V, I_D = 200mA$	
Static Drain-Source On-Resistance	R _{DS(ON)}	—	288	560	mΩ	$V_{GS} = 2.5V, I_D = 100mA$	
			324	730		V _{GS} = 1.8V, I _D = 75mA	
Diode Forward Voltage	V _{SD}		0.7	1.2	V	$V_{GS} = 0V, I_{S} = 300mA$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	—	73	—	рF		
Output Capacitance	Coss	—	7.2	—	рF	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	5	_	pF		
Gate Resistance	Rg	—	902	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Qg	_	5.5	_	nC		
Gate-Source Charge	Q _{gs}	_	0.8	_	nC	V _{GS} = 4.5V, V _{DS} = 15V, - I _D = 1A	
Gate-Drain Charge	Q _{gd}		1.4		nC	ID = IA	
Turn-On Delay Time	t _{D(ON)}	_	2.5	_	ns		
Turn-On Rise Time	t _R		3.1		ns	$V_{DS} = 10V, I_{D} = 1A$	
Turn-Off Delay Time	t _{D(OFF)}	—	477	—	ns	$V_{GS} = 10V, R_g = 6\Omega$	
Turn-Off Fall Time	t _F		123		ns		
Reverse Recovery Time	t _{RR}	—	59	—	ns		
Reverse Recovery Charge	Q _{RR}		25		nC	- I _F = 1A, di/dt = 100A/μs	

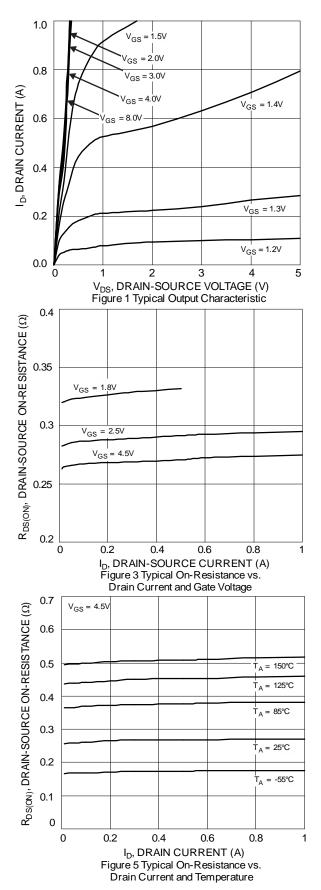
Notes:

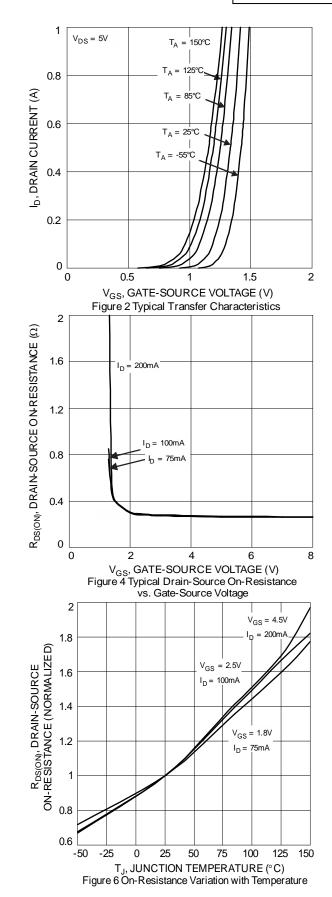
Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to production testing.

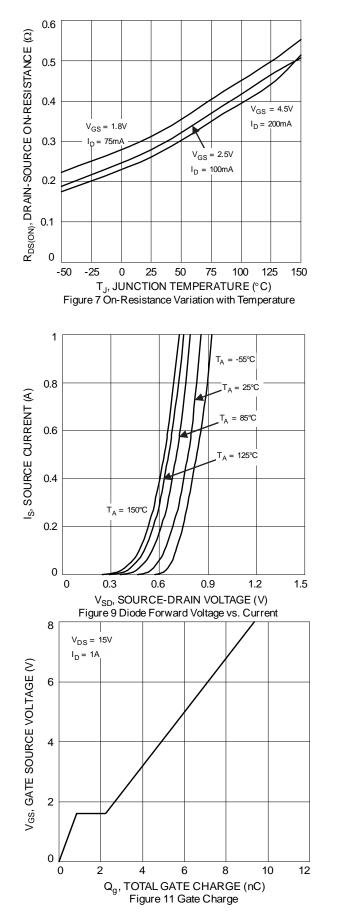


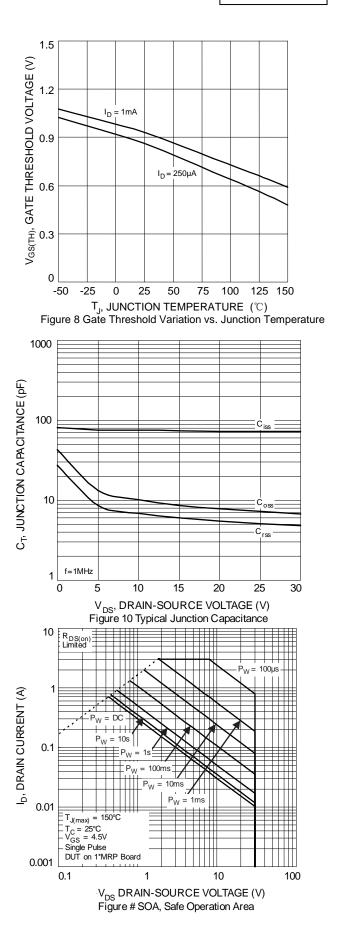




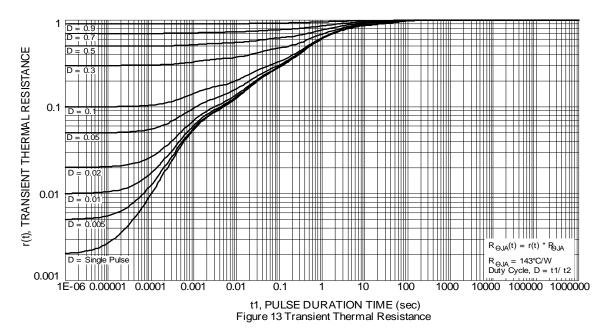










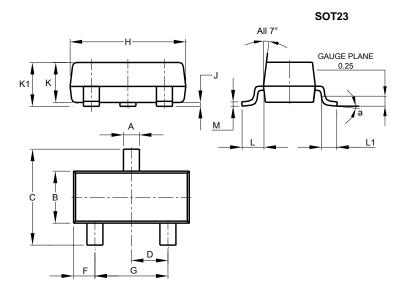




DMN3731U

Package Outline Dimensions

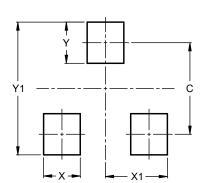
Please see http://www.diodes.com/package-outlines.html for the latest version.



	SOT23							
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
В	1.20	1.40	1.30					
c	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
н	2.80	3.00	2.90					
J	0.013	0.10	0.05					
ĸ	0.890	1.00	0.975					
K1	0.903	1.10	1.025					
L	0.45	0.61	0.55					
L1	0.25	0.55	0.40					
Μ	0.085	0.150	0.110					
а	0°	8°						
All	Dimens	ions in	mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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